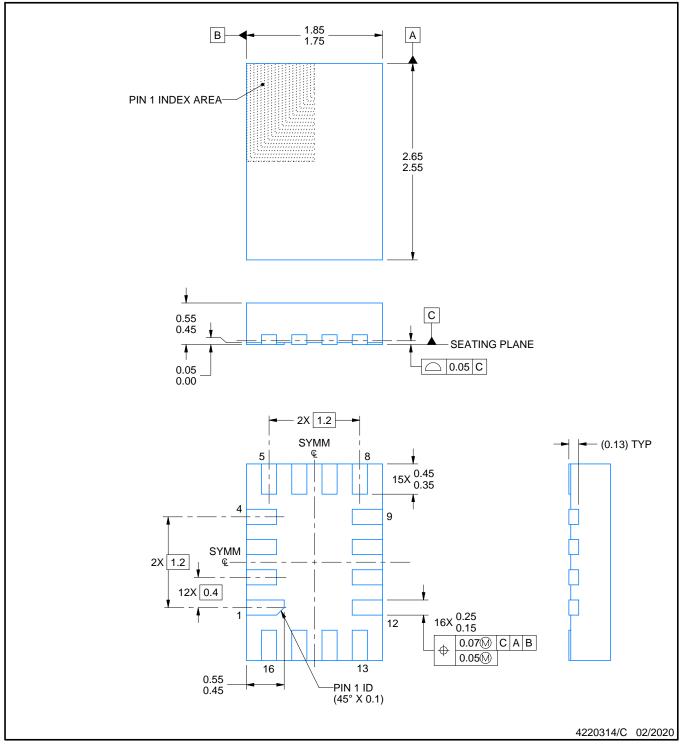
RSV0016A



PACKAGE OUTLINE

UQFN - 0.55 mm max height

ULTRA THIN QUAD FLATPACK - NO LEAD



NOTES:

All linear dimensions are in millimeters. Any dimensions in parenthesis are for reference only. Dimensioning and tolerancing per ASME Y14.5M.
This drawing is subject to change without notice.

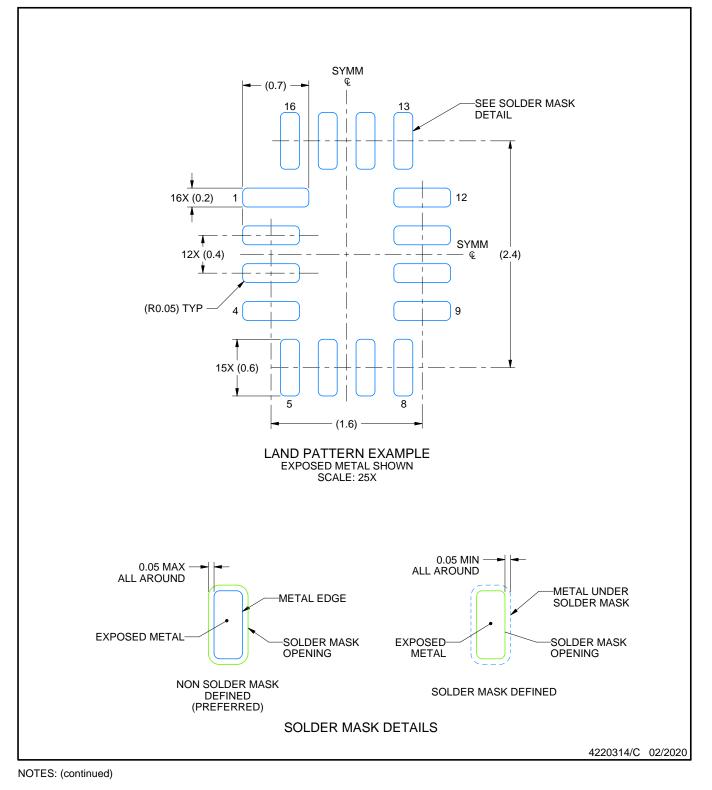


RSV0016A

EXAMPLE BOARD LAYOUT

UQFN - 0.55 mm max height

ULTRA THIN QUAD FLATPACK - NO LEAD



3. For more information, see Texas Instruments literature number SLUA271 (www.ti.com/lit/slua271).

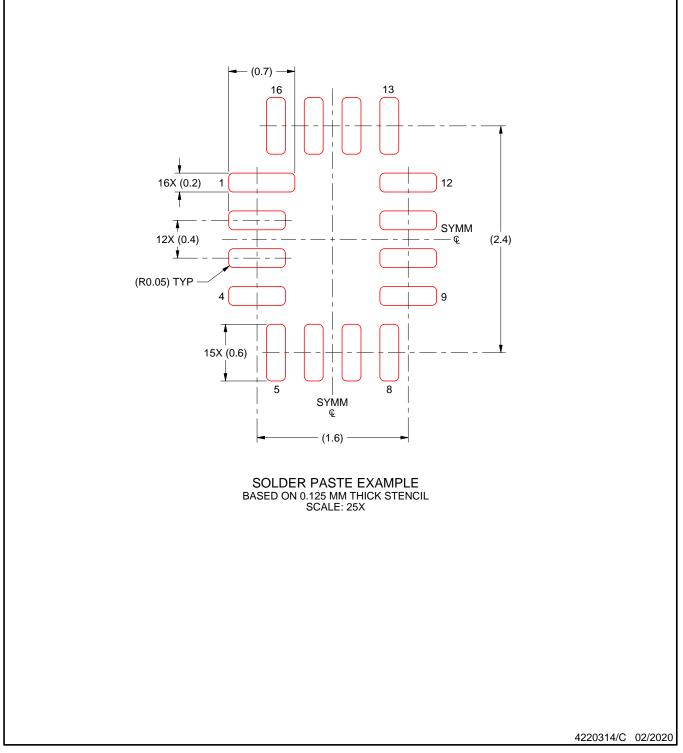


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EXAMPLE STENCIL DESIGN

UQFN - 0.55 mm max height

ULTRA THIN QUAD FLATPACK - NO LEAD



NOTES: (continued)

4. Laser cutting apertures with trapezoidal walls and rounded corners may offer better paste release. IPC-7525 may have alternate design recommendations.



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